

# ESD130-B1-W0201

## Protection device

TVS (transient voltage suppressor)

Bi-directional, 5.5 V, 0.3 pF, 0201, RoHS and halogen free compliant

## Features

- ESD/transient protection of high speed data lines according to:
  - IEC61000-4-2 (ESD):  $\pm 18$  kV (air/contact discharge)
  - IEC61000-4-4 (EFT):  $\pm 2.5$  kV/ $\pm 50$  A (5/50 ns)
  - IEC61000-4-5 (Surge):  $\pm 2.5$  A (8/20  $\mu$ s)
- Bi-directional working voltage up to:  $V_{RWM} = \pm 5.5$  V
- Line capacitance:  $C_L = 0.3$  pF (typical) at  $f = 1$  MHz
- Clamping voltage:  $V_{CL} = 20$  V (typical) at  $I_{TLP} = 16$  A with  $R_{DYN} = 0.8 \Omega$  (typical)
- Very low reverse current:  $I_R < 1$  nA (typical)
- Small form factor SMD size 0201 and low profile (0.58 mm x 0.28 mm x 0.15 mm); for further package information please refer to application note AN392 [3]
- Bi-directional and symmetric I/V characteristics for optimized design/assembly



## Potential applications

- USB 3.0, Firewire, DVI, HDMI, S-ATA, DisplayPort, Thunderbolt
- Mobile HDMI link, MDDI, MIPI, SWP/NFC

## Product validation

Qualified for industrial applications according to the relevant tests of JEDEC47/20/22

## Device information

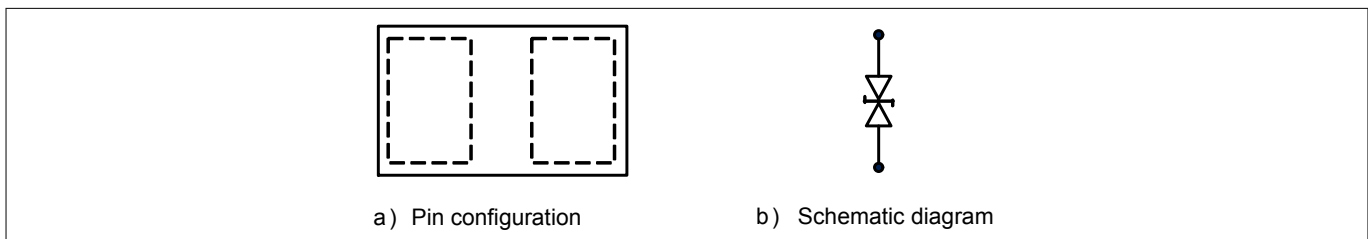


Figure 1 Pin configuration and schematic diagram

Table 1 Part information

Type	Package	Configuration	Marking code
ESD130-B1-W0201	WLL-2-1	1 line, bi-directional	C <sup>1)</sup>

<sup>1</sup> The device does not have any marking or date code on the device backside. The marking code is on pad side.

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Maximum ratings

## 1 Maximum ratings

Note:  $T_A = 25\text{ }^\circ\text{C}$ , unless otherwise specified.

Table 2 Maximum ratings

Parameter	Symbol	Values	Unit	Note or test condition
Reverse working voltage	$V_{RWM}$	$\pm 5.5$	V	–
ESD (air/contact) discharge <sup>1)</sup>	$V_{ESD}$	$\pm 18$	kV	–
Peak pulse power <sup>2)</sup>	$P_{PK}$	27.5	W	–
Peak pulse current <sup>2)</sup>	$I_{PP}$	$\pm 2.5$	A	–
Operating temperature range	$T_{OP}$	-55 to 125	$^\circ\text{C}$	–
Storage temperature	$T_{stg}$	-65 to 150	$^\circ\text{C}$	–

**Attention:** Stresses above the maximum values listed here may cause permanent damage to the device. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Maximum ratings are absolute ratings. Exceeding only one of these values may cause irreversible damage to the component.

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<sup>1</sup>  $V_{ESD}$  according to IEC61000-4-2 ( $R = 330\ \Omega$ ,  $C = 150\ \text{pF}$  discharge network)

<sup>2</sup> Stress pulse: 8/20  $\mu\text{s}$  current waveform according to IEC61000-4-5

Electrical characteristics

2 Electrical characteristics

Note:  $T_A = 25\text{ }^\circ\text{C}$ , unless otherwise specified. Device is electrically symmetrical.

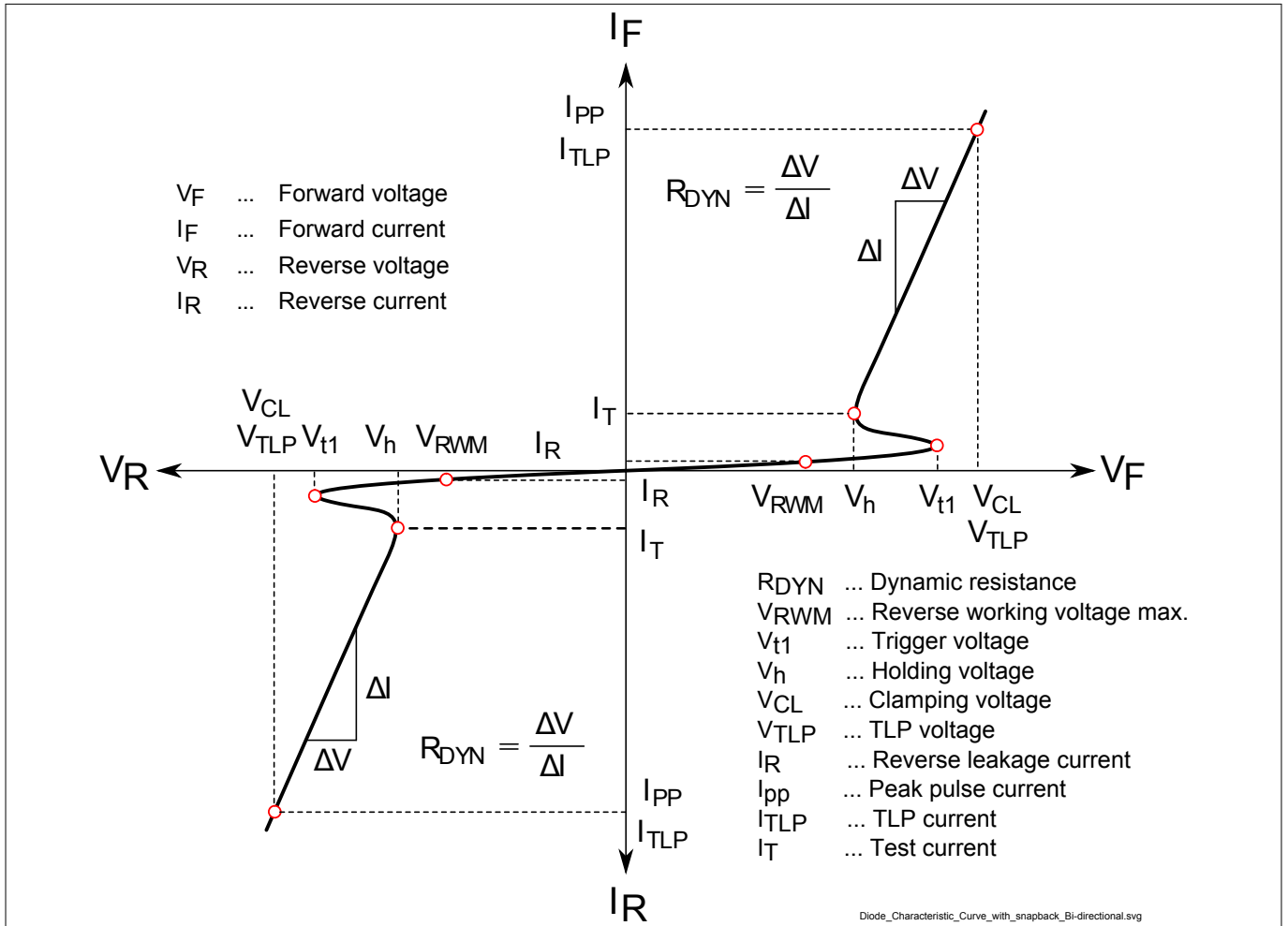


Figure 2 Definitions of electrical characteristics

**Electrical characteristics**

**Table 3 DC characteristics**

Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Typ.	Max.		
Reverse current	$I_R$	–	<1	20	nA	$V_R = 5.5\text{ V}$
Trigger voltage	$V_{t1}$	5.5	–	–	V	–
Holding voltage	$V_h$	6.1	7	9	V	$I_R = 10\text{ mA}$

**Table 4 AC characteristics**

Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Typ.	Max.		
Line capacitance	$C_L$	–	0.3	0.4	pF	$V_R = 0\text{ V}, f = 1\text{ MHz}$
		–	0.25	–		$V_R = 0\text{ V}, f = 1\text{ GHz}$

**Table 5 ESD and Surge characteristics**

Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Typ.	Max.		
Clamping voltage <sup>1)</sup>	$V_{CL}$	–	–	27	V	$I_{TLP} = 16\text{ A}, t_p = 100\text{ ns}$
		–	–	41		$I_{TLP} = 30\text{ A}, t_p = 100\text{ ns}$
Clamping voltage <sup>2)</sup>		–	–	12		$I_{PP} = 1\text{ A}, t_p = 8/20\text{ }\mu\text{s}$
		–	–	18.5		$I_{PP} = 2.5\text{ A}, t_p = 8/20\text{ }\mu\text{s}$
Dynamic resistance <sup>1)</sup>	$R_{DYN}$	–	0.8	–	$\Omega$	$t_p = 100\text{ ns}$

<sup>1</sup> Please refer to application note AN210 [1], TLP parameters:  $Z_0 = 50\ \Omega$ ,  $t_p = 100\text{ ns}$ ,  $t_r = 0.6\text{ ns}$

<sup>2</sup> Stress pulse: 8/20  $\mu\text{s}$  current waveform according to IEC61000-4-5

Typical characteristic diagrams

### 3 Typical characteristic diagrams

Note:  $T_A = 25\text{ }^\circ\text{C}$ , unless otherwise specified.

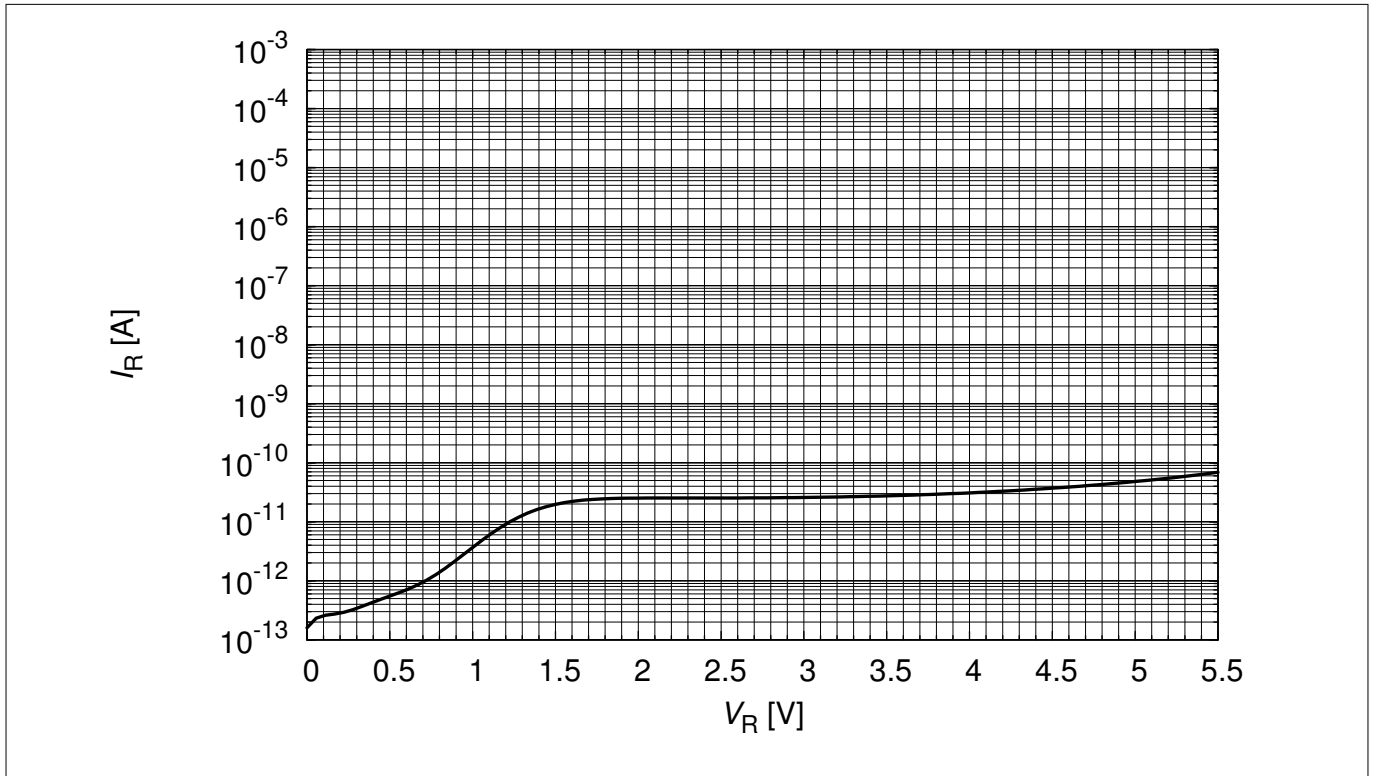


Figure 3 Reverse leakage current:  $I_R = f(V_R)$

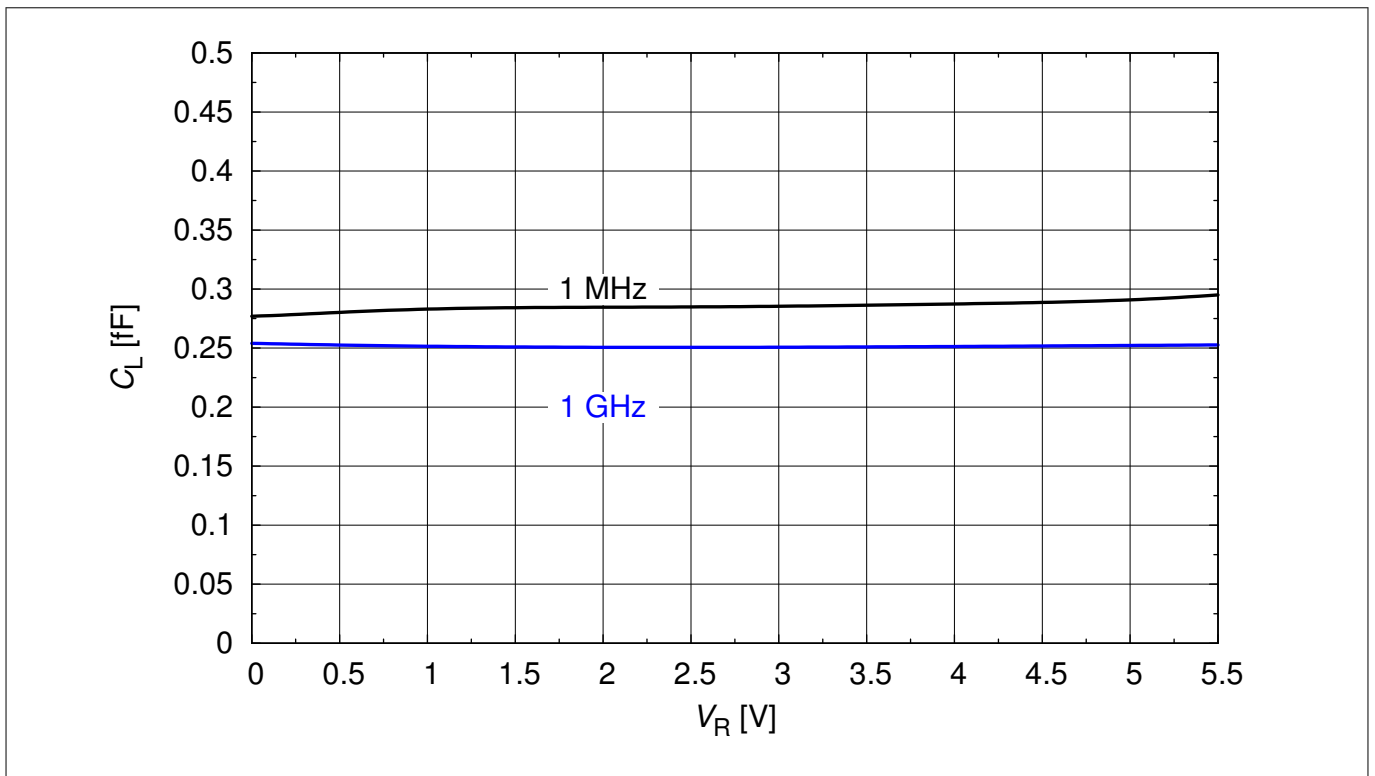


Figure 4 Line capacitance:  $C_L = f(V_R)$

Typical characteristic diagrams

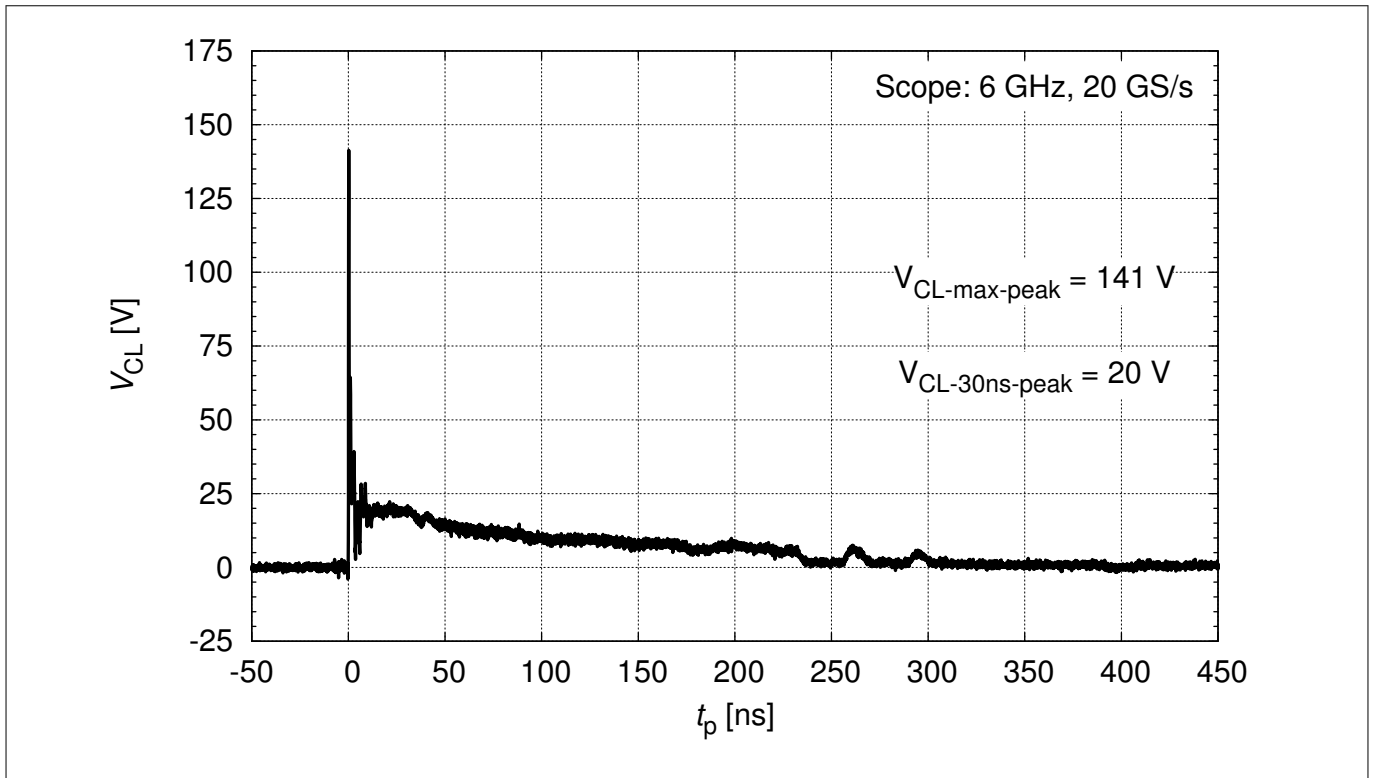


Figure 5 Clamping voltage (ESD):  $V_{CL} = f(t)$ , 8 kV positive pulse (according to IEC61000-4-2)

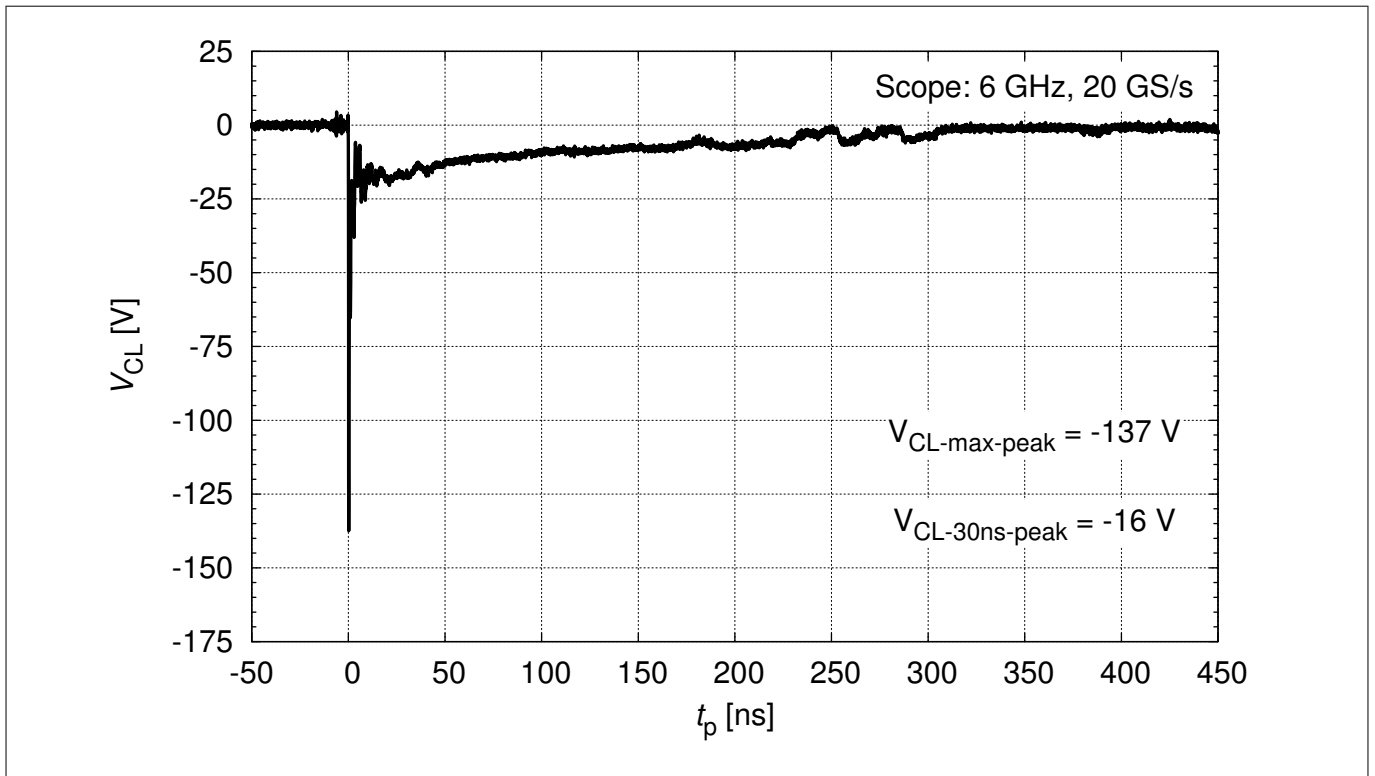


Figure 6 Clamping voltage (ESD):  $V_{CL} = f(t)$ , 8 kV negative pulse (according to IEC61000-4-2)

Typical characteristic diagrams

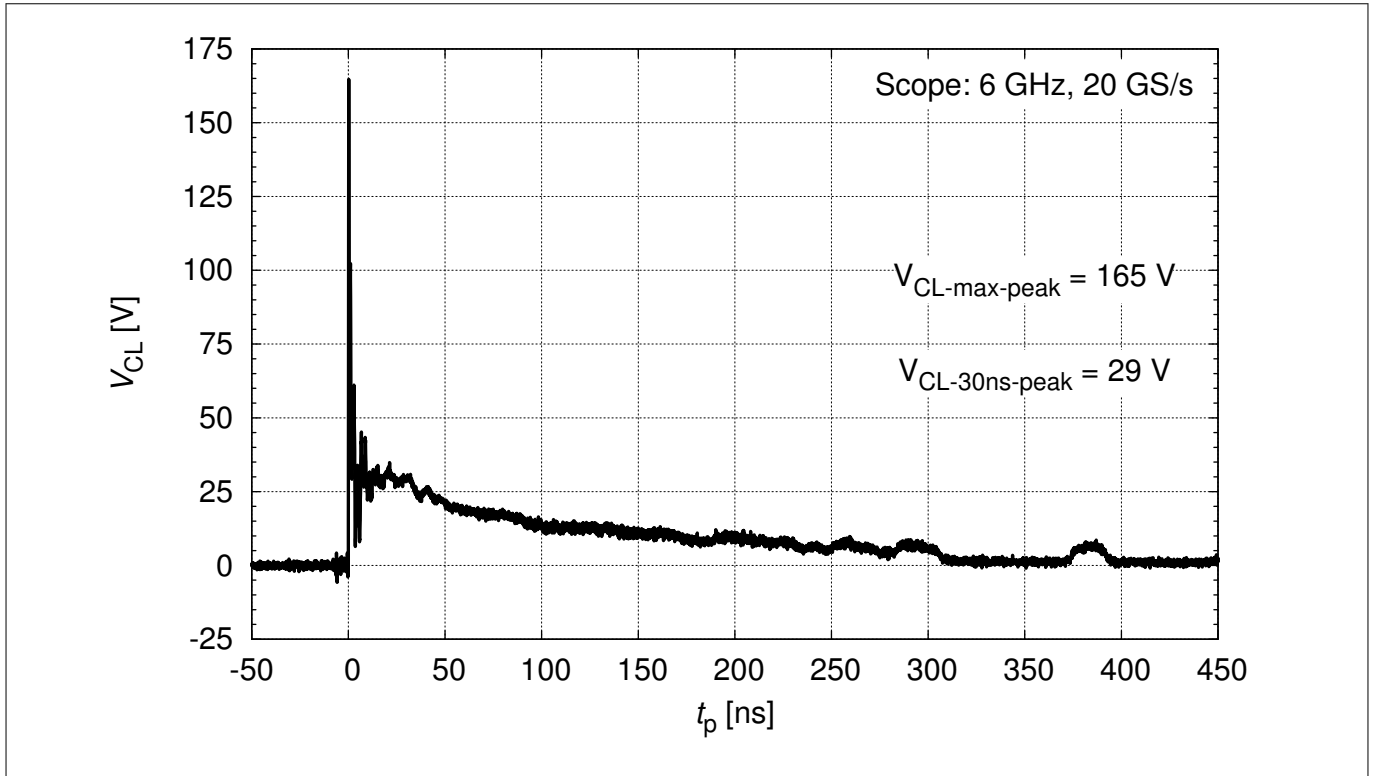


Figure 7 Clamping voltage (ESD):  $V_{CL} = f(t)$ , 15 kV positive pulse (according to IEC61000-4-2)

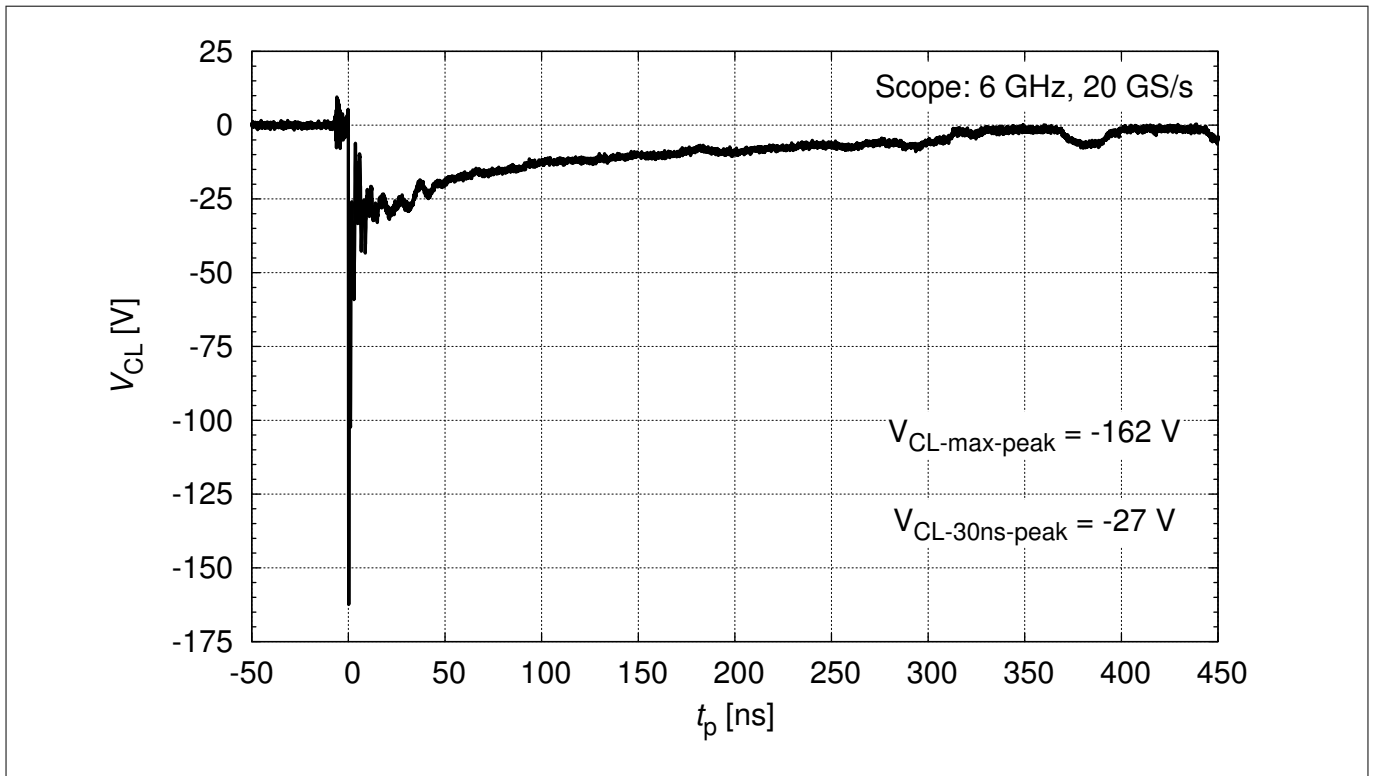


Figure 8 Clamping voltage (ESD):  $V_{CL} = f(t)$ , 15 kV negative pulse (according to IEC61000-4-2)



Typical characteristic diagrams

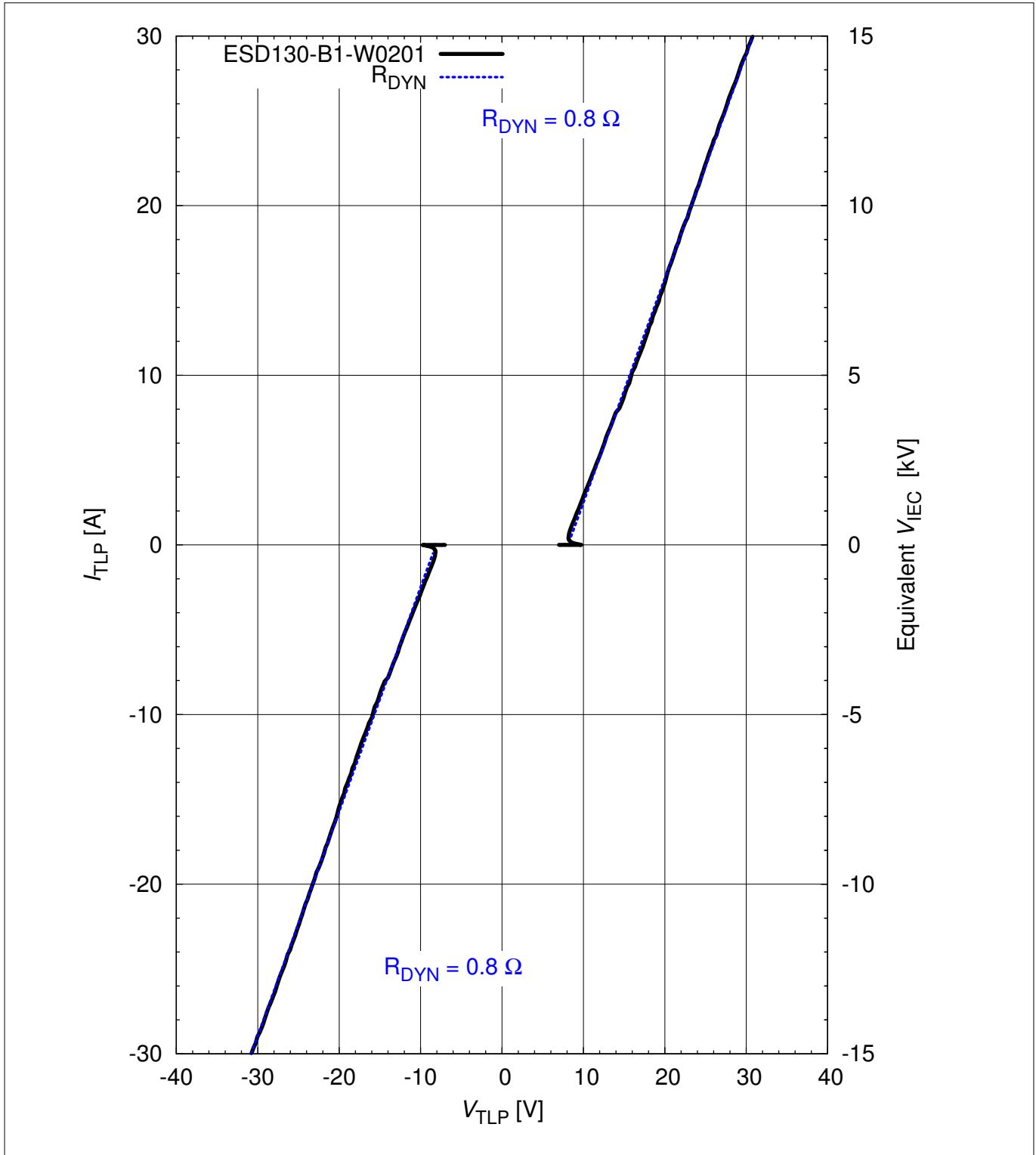


Figure 9 Clamping voltage (TLP):  $I_{TLP} = f(V_{TLP})$  [1]

Typical characteristic diagrams

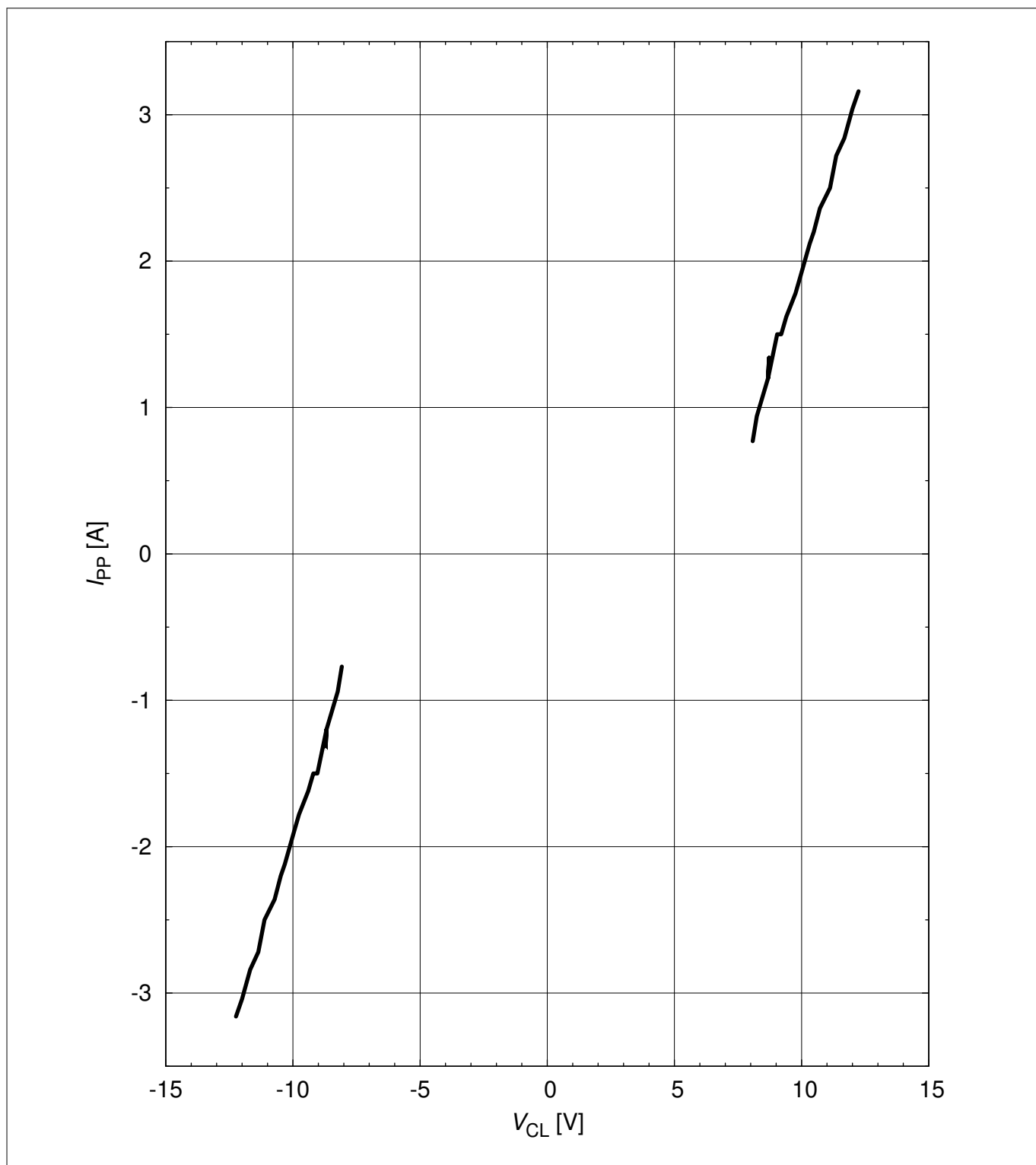
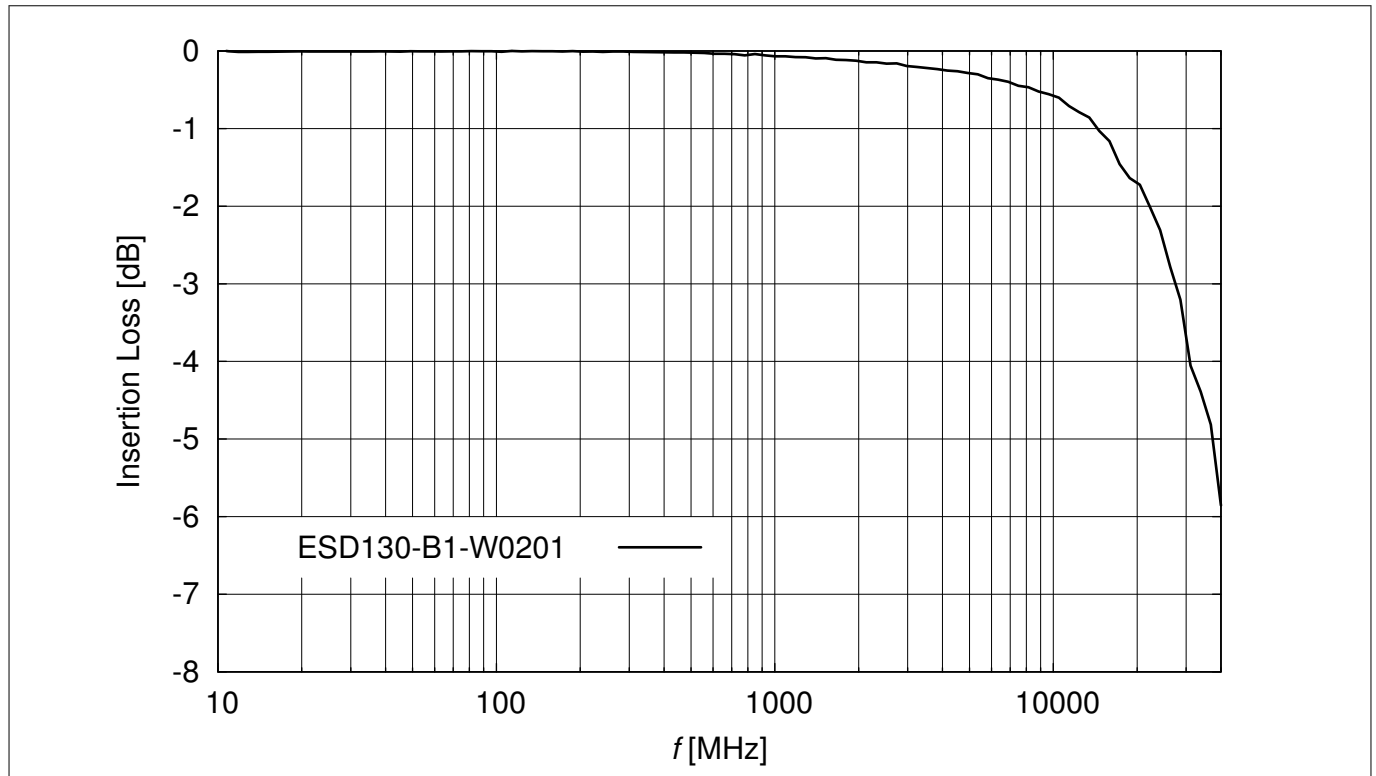


Figure 10 Clamping voltage (Surge):  $I_{PP} = f(V_{CL})$  (according to IEC61000-4-5) [1]

Typical characteristic diagrams



**Figure 11** Insertion loss vs. frequency in a 50  $\Omega$  system

Package information

## 4 Package information

### 4.1 WLL-2-1 package

Note: Dimensions in mm.

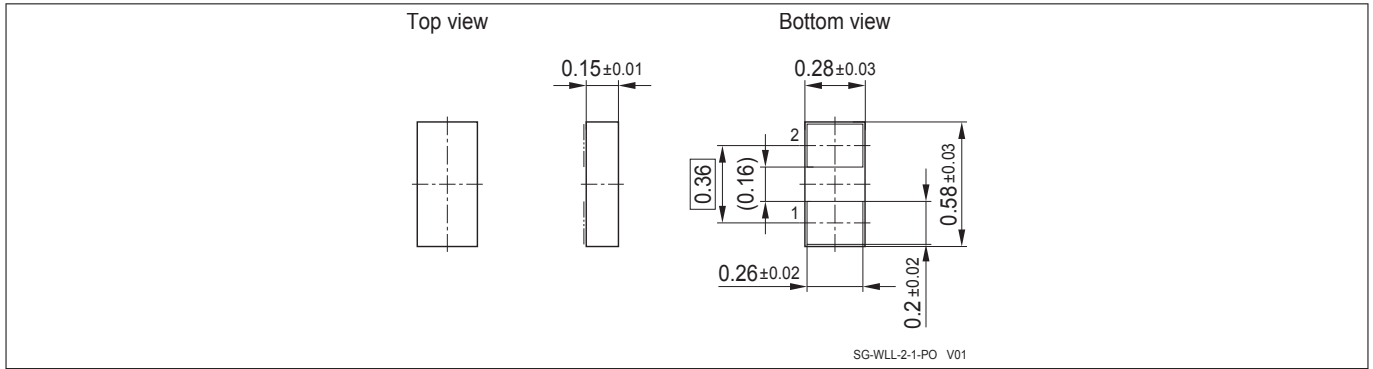


Figure 12 WLL-2-1 package outline

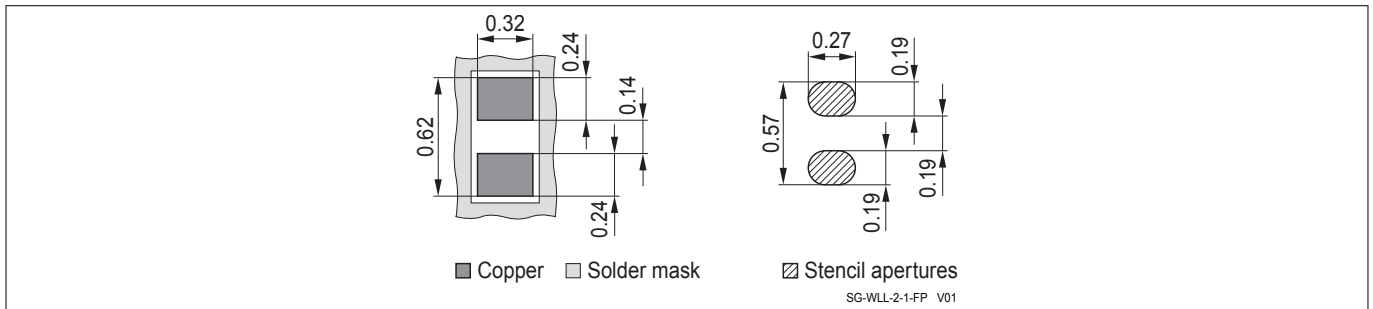


Figure 13 WLL-2-1 footprint (recommendation for printed circuit board assembly see [2])

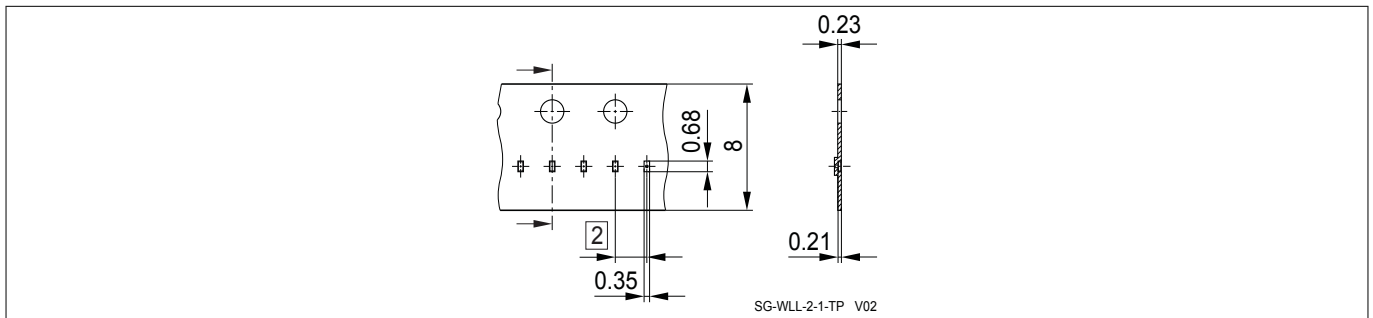


Figure 14 WLL-2-1 packing

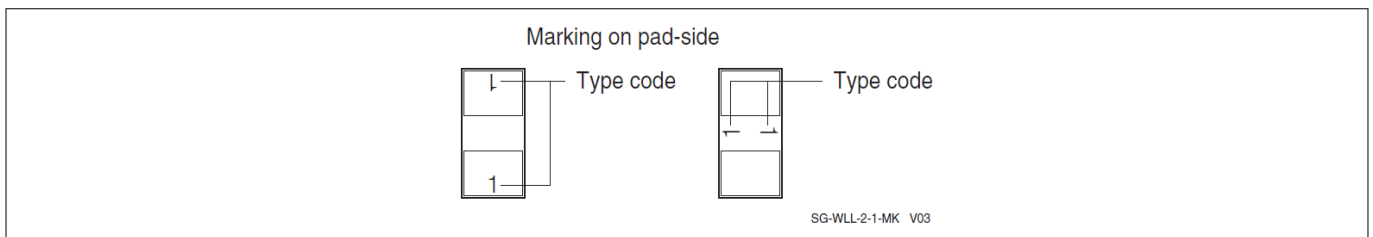


Figure 15 WLL-2-1 marking example (see Device information)

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References

## 5 References

- [1] Infineon AG - **Application note AN210**: Effective ESD protection design at system level using VF-TLP characterization methodology
- [2] Infineon AG - **Recommendation for Printed Circuit Board Assembly of Infineon WLL Packages**  
[http://www.infineon.com/Packageinformation\\_WLL](http://www.infineon.com/Packageinformation_WLL)
- [3] Infineon AG - **Application note AN392**: TVS diodes in ChipScalePackage reduce size and save cost

## Revision history

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**Revision history: Rev. 1.0. 2016-05-10**

Page or Item	Subjects (major changes since previous revision)
Revision 1.1, 2017-09-28	
All	Data sheet layout changed, references updated

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